Commercial "L" Series, SnPb Termination, X7R Dielectric 6.3V – 250 VDC (Commercial Grade)



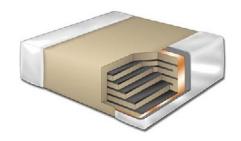
Overview

KEMET's Commercial "L" Series with Tin/Lead Termination surface mount capacitors in X7R dielectric are designed to meet the needs of critical applications where tin/lead end metallization is required. KEMET's tin/lead electroplating process is designed to meet a 5% minimum lead content and address concerns for a more robust and reliable lead containing termination system. As the bulk of the electronics industry moves towards RoHS compliance, KEMET continues to provide tin/lead terminated products for military, aerospace and industrial applications and will ensure customers have a stable and long-term source of supply.

KEMET's X7R dielectric features a 125°C maximum operating temperature and is considered "temperature stable." The Electronics Components, Assemblies & Materials Association (EIA) characterizes X7R dielectric as a Class II material. Components of this classification are fixed, ceramic dielectric capacitors suited for bypass and decoupling applications or for frequency discriminating circuits where Q and stability of capacitance characteristics are not critical. X7R exhibits a predictable change in capacitance with respect to time and voltage and boasts a minimal change in capacitance with reference to ambient temperature. Capacitance change is limited to ±15% from -55°C to +125°C.

Benefits

- -55°C to +125°C operating temperature range
- Temperature stable dielectric
- · Reliable and robust termination system
- EIA 0402, 0603, 0805, 1206, 1210, 1808, 1812, 1825, 2220, and 2225 case sizes
- DC voltage ratings of 6.3 V, 10 V, 16 V, 25 V, 50 V, 100 V, 200 V, and 250 V
- Capacitance offerings ranging from 10 pF to 22 μF
- Available capacitance tolerances of ±5%, ±10%, and ±20%



Ordering Information

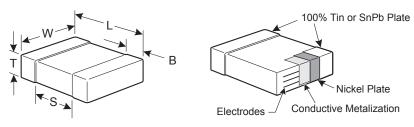
С	1206	С	226	K	8	R	Α	С	TU
Ceramic	Case Size (L" x W")	Specification/ Series	Capacitance Code (pF)	Capacitance Tolerance	Voltage	Dielectric	Failure Rate/ Design	Termination Finish ¹	Packaging/Grade (C-Spec) ²
	0402 0603 0805 1206 1210 1808 1812 1825 2220 2225	C = Standard	2 Significant Digits + Number of Zeros	J = ±5% K = ±10% M = ±20%	9 = 6.3 V 8 = 10 V 4 = 16 V 3 = 25 V 6 = 35 V 5 = 50 V 1 = 100 V 2 = 200 V A = 250 V	R = X7R	A = N/A	L = SnPb (5% minimum)	Blank = Bulk TU = 7" Reel Unmarked TM = 7" Reel Marked

¹ Additional termination finish options may be available. Contact KEMET for details

² Additional reeling or packaging options may be available. Contact KEMET for details.



Dimensions – Millimeters (Inches)



EIA Size Code	Metric Size Code	L Length	W Width	T Thickness	B Bandwidth	S Separation Minimum	Mounting Technique
0402	1005	1.00 (.040) ± 0.05 (.002)	0.50 (.020) ± 0.05 (.002)		0.30 (.012) ± 0.10 (.004)	0.30 (.012)	Solder Reflow Only
0603	1608	1.60 (.063) ± 0.15 (.006)	0.80 (.032) ± 0.15 (.006)		0.35 (.014) ± 0.15 (.006)	0.70 (.028)	0 11 14
0805	2012	2.00 (.079) ± 0.20 (.008)	1.25 (.049) ± 0.20 (.008)		0.50 (0.02) ± 0.25 (.010)	0.75 (.030)	Solder Wave or Solder Reflow
1206	3216	3.20 (.126) ± 0.20 (.008)	1.60 (.063) ± 0.20 (.008)		0.50 (0.02) ± 0.25 (.010)		Solder Reliow
1210¹	3225	3.20 (.126) ± 0.20 (.008)	2.50 (.098) ± 0.20 (.008)	See Table 2 for	0.50 (0.02) ± 0.25 (.010)		
1808	4520	4.70 (.185) ± 0.50 (.020)	2.00 (.079) ± 0.20 (.008)	Thickness	0.60 (.024) ± 0.35 (.014)		
1812	4532	4.50 (.177) ± 0.30 (.012)	3.20 (.126) ± 0.30 (.012)		0.60 (.024) ± 0.35 (.014)	N/A	Caldan Daffass Only
1825	4564	4.50 (.177) ± 0.30 (.012)	6.40 (.252) ± 0.40 (.016)		0.60 (.024) ± 0.35 (.014)		Solder Reflow Only
2220	5650	5.70 (.224) ± 0.40 (.016)	5.00 (.197) ± 0.40 (.016)		0.60 (.024) ± 0.35 (.014)		
2225	5664	5.60 (.220) ± 0.40 (.016)	6.40 (.248) ± 0.40 (.016)		0.60 (.024) ± 0.35 (.014)		

¹ For capacitance values ≥ 12 μF add 0.02 (0.001) to the width tolerance dimension

Benefits cont'd

- · Non-polar device, minimizing installation concerns
- SnPb plated termination finish (5% minimum)
- · Flexible termination option available upon request
- Available for other surface mount products, additional dielectrics and higher voltage ratings upon request

Applications

Typical applications include military, aerospace and other high reliability applications.

Qualification/Certification

Commercial Grade products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 4, Performance & Reliability.

Environmental Compliance

These devices do not meet RoHS criteria due to the concentration of Pb containment in the termination finish



Electrical Parameters/Characteristics

Item	Parameters/Characteristics
Operating Temperature Range	-55°C to +125°C
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	±15%
Aging Rate (Maximum % Capacitance Loss/Decade Hour)	3.0%
Dielectric Withstanding Voltage (DWV)	250% of rated voltage (5 ±1 seconds and charge/discharge not exceeding 50 mA)
Dissipation Factor (DF) Maximum Limit @ 25°C	5% (6.3 and 10 V), 3.5% (16 and 25 V) and 2.5% (50 to 250 V)
Insulation Resistance (IR) Limit @ 25°C	See Insulation Resistance Limit Table (Rated voltage applied for 120 ±5 seconds @ 25°C)

Regarding aging rate: Capacitance measurements (including tolerance) are indexed to a referee time of 1,000 hours.

To obtain IR limit, divide $M\Omega$ - μ F value by the capacitance and compare to $G\Omega$ limit. Select the lower of the two limits.

Capacitance and dissipation factor (DF) measured under the following conditions:

1 kHz ± 50 Hz and 1.0 ± 0.2 Vrms if capacitance $\leq 10~\mu F$

120 Hz ± 10 Hz and 0.5 ± 0.1 Vrms if capacitance > 10 μF

Note: When measuring capacitance it is important to ensure the set voltage level is held constant. The HP4284 and Agilent E4980 have a feature known as Automatic Level Control (ALC). The ALC feature should be switched to "ON."

Post Environmental Limits

	High Temperatu	ıre Life, Biased	Humidity, Moist	ture Resistance)
Dielectric	Rated DC Voltage	Capacitance Value	Dissipation Factor (Maximum %)	Capacitance Shift	Insulation Resistance
	> 25		3.0		
X7R	16/25	All	5.0	±20%	10% of Initial Limit
	< 16		7.5		

Insulation Resistance Limit Table (X7R Dielectric)

EIA Case Size	1,000 Megohm Microfarads or 100 GΩ	500 Megohm Microfarads or 10 GΩ
0201	N/A	ALL
0402	< 0.012 µF	≥ 0.012 µF
0603	< 0.047 µF	≥ 0.047 µF
0805	< 0.047 µF	≥ 0.047 µF
1206	< 0.22 µF	≥ 0.22 µF
1210	< 0.39 µF	≥ 0.39 µF
1808	ALL	N/A
1812	< 2.2 µF	≥ 2.2 µF
1825	ALL	N/A
2220	< 10 µF	≥ 10 µF
2225	ALL	N/A



Table 1A – Capacitance Range/Selection Waterfall (0402 – 1206 Case Sizes)

		S	erie	es		С	040	2				С	060)3						C	080)5							C	120)6			
	Cap	Vol	tage (Code	9	8	4	3	5	9	8	4	3	5	1	2	9	8	4	3	6	5	1	2	Α	9	8	4	3	6	5	1	2	Α
Capacitance	Code	Vo	ltage	DC	6.3	9	16	52	20	6.3	9	9	52	20	5	200	6.3	9	9	52	35	20	100	200	250	6.3	9	9	52	35	20	5	200	250
			pacita			P	rod	uct	Ava	ailal	oilit	y aı	nd C	Chip	Th	ickı	nes	s Co	ode	s – \$	See	Tak	le 2	2 fo	r Ch	nip 1	Γhic	kne	ess	Dim	ens	ion	s	
10 - 91 pF	100-910	J	K	M	ВВ	ВВ	ВВ	BB	ВВ	СВ	СВ	СВ	СВ	СВ	СВ	СВ	DC	DC	DC	DC	DC	DC	DC	DC		EB	EB	EB	EB	EB	EB	EB	EB	
100 - 150 pF	101-151	J	K	M	ВВ	ВВ	BB	ВВ	ВВ	СВ	СВ	СВ	СВ	СВ	СВ	СВ	DC	DC	DC	DC	DC	DC	DC	DC		EB	EB	EB	EB	EB	EB	EB	EB	
180 - 820 pF	181-821	J	K	M	BB	BB	BB	BB	BB	СВ	CB	CB	СВ	CB	CB	СВ	DC		DC	DC	DC	DC	DC	DC	DC	EB	EB	EB	EB	EB	EB	EB	EB	
1000pF	102	J	K	M	BB	BB	BB	BB	BB	СВ	CB	CB	CB	CF	CB	CF	DC	DC	DC	DC	DC	DC	DC	DC	DC	EB	EB	EB	EB	EB	EB	EB	EB	EB
1200 pF	122	J	K	M	BB	BB	BB	BB	BB	СВ	CB	СВ	СВ	CB	CB	CB	DC	DC	DC	DC	DC	DC	DC	DC	DC	EB	EB	EB	EB	EB	EB	EB	EB	EB
1500 pF	152	J	K	M	BB	BB	BB	BB	BB	СВ	CB	CB	СВ	CB	CB	СВ	DC		DC	DC	DC	DC	DC	DC	DC	EB	EB	EB	EB	EB	EB	EB	EB	ΕB
1800 pF	182	J	K	M	BB	ВВ	BB	ВВ	BB	СВ	СВ	СВ	СВ	СВ	СВ	СВ	DC	DC	DC	DC	DC	DC	DC	DC	DC	EB	EB	EB	EB	EB	EB	EB	EB	EB
2200 pF	222	J	K	M	ВВ	BB	BB	ВВ	BB	СВ	СВ	СВ	СВ	CF	СВ	СВ	DC	DC	DC	DC	DC	DC	DC	DC	DC	EB	EB	EB	EB	EB	EB	EB	EB	EB
2700 pF	272	J	K	M	ВВ	BB	BB	BB	BB	CB	СВ	CB	CB	СВ	CF	СВ	DC				1											1		
3300 pF	332	J	K	M	BB	BB	BB	BB	BB	CB	СВ	СВ	CB	СВ	СВ	СВ	DC											_	_		_			
3900 pF	392	J	K	M	BB	BB	BB	BB	BB	CB	CB	CB	CB	CB	СВ	CB	DC																	
4700 pF	472	J	K	M	BB	BB	BB	BB	BB	CB	CB	CB	CB	CB	CB	CB	DC																	
5600 pF	562	J	K	M	BB	BB	BB	BB	BB	CB	CB	CB	CB	CB	CB	CB	DC		DC DC DC DC DC DC EB DC DC DC															
6800 pF	682	J	K	M	BB	BB	BB	BB	BB	CB	CB	CB	CB	CB	CB	CB	DC																	
8200 pF	822	J	K	M	BB	BB	BB	BB	BB	CB	CB	CB	CB	CB	CB	CB	DC		-															
10000 pF	103	J	K	M	BB BB	BB	BB	BB	BB BB	CB	CB	CB	CB	CF CB	CF	СВ	DC				1											1		
12000 pF 15000 pF	123 153	J	K	M	BB	BB BB	BB BB	BB BB	BB	CB CB	CB CB	CB CB	CB CB	CB	CB CB		DC DC				1				-							1		
18000 pF	183		K	M	ВВ	BB	BB	BB	BB	СВ	СВ	СВ	СВ	CB	СВ		DC				1											1		
22000 pF	223	J	K	M	ВВ	BB	BB	BB	BB	СВ	СВ	СВ	СВ	CF	CF		DC				1				-							1		
27000 pF 27000 pF	273	J	K	M	BB	BB	BB	BB	DD	СВ	СВ	СВ	СВ	СВ	СВ		DC		-						DC			_						
33000 pF	333	J	K	M	BB	BB	BB	BB		СВ	СВ	CB	CF	СВ	СВ		DC																	
39000 pF	393	J	K	M	BB	BB	BB	BB		CB	CB	CB	CB	СВ	СВ		DC																	
47000 pF	473	J	K	M	BB	BB	BB	BB		CB	CB	CB	CB	CF	CB		DC																	
56000 pF	563	J	K	M	BB	BB	BB	טט		CB	СВ	CB	CB	CB	ОВ		DD																	
68000 pF	683	J	K	M	BB	BB	BB			CB	СВ	СВ	СВ	CF			DD		D DD DD DD DD DE EB EB EB EB EB EB EB ED ED															
82000 pF	823	Ĵ	K	M	BB	BB	BB			CB	CB	CB	CB	CB			DD	DD																
0.1 µF	104	Ĵ	K	M		BB	BB			СВ	CB	CF	СВ	CF			DC	D DD DD DD DD DD DD DE EB																
0.12 µF	124	Ĵ	K	M						СВ	CB	CB	СВ	CB			DC	DC																
0.15 µF	154	Ĵ	K	М	i					CB	СВ	СВ	СВ	СВ			DC				1											1		
0.18 µF	184	J	K	M						СВ	СВ	CB	CB	0.5			DC		_				_				_		_	-	_			
0.22 µF	224	Ĵ	K	M						СВ	СВ	СВ	СВ				DC																	
0.27 µF	274	Ĵ	K	М						СВ	СВ	СВ					DD																	
0.33 µF	334	J	K	М						СВ	СВ	СВ					DG	DG	DG	DG	DD	DD				EB	EB	EB	EB	EC	EC	EG		
0.39 µF	394	Ĵ	K	M						CB	СВ	CB					DG		DG	DG	DE	DE				EB	EB	EB	EB	EC	EC	EG		
0.47 µF	474	J	K	М						СВ	СВ	СВ					DG		DG	DG	DE	DE				EC	EC	EC	EC	EC	EC	EG		
0.56 µF	564	J	K	М	l												DD	DD	DD	DG	DH	DH				ED	ED	ED	ED	EC	EC			
0.68 µF	684	J	K	M													DD	DD	DD	DG	DH	DH				EE	EE	EE	EE	ED	ED			
0.82 μF	824	J	K	M													DD	DD	DD	DG						EF	EF	EF	EF	ED	ED			
1 μF	105	J	K	М													DD	DD	DD	DG						EF	EF	EF	EG	ED	ED			
1.2 µF	125	J	K	M													DE	DE	DE							ED	ED	ED	EG	EH	EH			
1.5 µF	155	J	K	M													DG	DG	DG							ED	ED	ED	EG	EH	EH			
1.8 µF	185	J	K	M														DG								ED	ED		EF	EH				
2.2 µF	225	J	K	M													DG	DG	DG							ED	ED		EF	EH	EH			
2.7 µF	275	J	K	M																						EN	EN		EH					
3.3 µF	335	J	K	M																						ED	ED							
3.9 µF	395	l i	K	M																						EF	EF	EF						
4.7 µF	475	J	K	M																						EF	EF	EF	EH					
5.6 µF	565	J	K	M																						EH	EH							
6.8 µF	685	J	K	M																						EH								
8.2 μF 10 μF	825 106	J	K	M																						EH	EH	EH						
ιν μι	100	_	Itage		6.3	ę	16	25	20	6.3	9	9	25	20	ş	200	6.3	9	91	52	35	20	100	200	250	6.3	은	9	25	35	20	ş	200	250
Canacitance	Сар	-	tage (8	4	3	5	9	8	4	3	5	1	2	9	8		3	6	5		2		9	8	4	3	6	5		2	A
Capacitance	Code	⊢			9				J	9	đ				1		l a	ď	4				1		Α	l a	ď	4	1			1		Α
		8	Serie	es		С	040	2				С	060	13						С	080	5							С	120	16			



Table 1B - Capacitance Range/Selection Waterfall (1210 - 2225 Case Sizes)

		S	erie	es				C12	210				C	180	8		C	181	2			C18	325			C	222	20			C2	225	
Consoitones	Сар	Volt	age C	Code	9	8	4	3	5	1	2	Α	5	1	2	3	5	1	2	Α	5	1	2	Α	3	5	1	2	Α	5	1	2	Α
Capacitance	Code	Vo	ltage	DC	6.3	9	16	25	20	100	200	250	50	100	200	25	20	100	200	250	50	100	200	250	25	20	100	200	250	50	100	200	250
			acita			Р	rod	uct	Ava	ilab	ility	, an	d C	hip '	Thic	kne	ess	Cod	les -	- Se	e Ta	able	2 fc	or C	hip	Thi	ckn	ess	Din	nen	sion	s	
10 - 91 pF	100-910	J	K	M	FB	FB	FB	FB	FB	FB	FB																						
100 - 270 pF	101-271	J	K	М	FB	FB	FB	FB	FB	FB	FB																						
330 pF	331	J	K	M	FB	FB	FB	FB	FB	FB	FB		LF	LF	LF																		
390 pF	391	J	K	M	FB	FB	FB	FB	FB	FB	FB		LF	LF	LF		OD	00	OD														
470 - 1,200 pF 1,500 pF	471-122 152	J	K	M	FB FB	FB FB	FB FB	FB FB	FB FB	FB FB	FB FE		LF LF	LF LF	LF LF	GB GB	GB GB	GB GB	GB GB														
1,800 pF	182	J	K	M	FB	FB	FB	FB	FB	FB	FE		LF	LF	LF	GB	GB	GB	GB														
2,200 pF	222	J	K	М	FB	FB	FB	FB	FB	FB	FB	FB	LF	LF	LF	GB	GB	GB	GB											İ			
2,700 pF	272	J	K	М	FB	FB	FB	FB	FB	FB	FB	FB	LF	LF	LF	GB	GB	GB	GB											l			
3,300 pF	332	J	K	М	FB	FB	FB	FB	FB	FB	FB	FB	LF	LF		GB	GB	GB	GB														
3,900 pF	392	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	LF	LF		GB	GB	GB	GB		НВ	HB	HB										
4,700 pF 5,600 pF	472 562	J	K	M	FB FB	FB FB	FB FB	FB FB	FB FB	FB FB	FB FB	FB FB	LD	LD LD	LD LD	GB GB	GB GB	GB GB	GD GH		HB HB	HB HB	HB HB							KE	KE	KE	
6,800 pF	682	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	LD	LD	LD	GB	GB	GB	GB	GB	НВ	НВ	НВ		JE	JE	JE			KE	KE	KE	
8,200 pF	822	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	LD	LD	LD	GB	GB	GB	GB	GB	НВ	HB	HB		JE	JE	JE			KE	KE	KE	
10,000 pF	103	J	K	М	FB	FB	FB	FB	FB	FB	FB	FB	LD	LD	LD	GB	GB	GB	GB	GB	НВ	НВ	HE		JE	JE	JE			KE	KE	KE	
12,000 pF	123	J	K	М	FB	FB	FB	FB	FB	FB	FB	FB	LD	LD	LD	GB	GB	GB	GB	GB	НВ	НВ	HE		JE	JE	JE			KE	KE	KE	
15,000 pF	153	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	LD	LD	LD	GB	GB	GB	GB	GB	НВ	НВ			JE	JE	JE			KE	KE	KE	
18,000 pF 22,000 pF	183 223	J	K	M	FB FB	FB FB	FB FB	FB FB	FB FB	FB FB	FB FB	FB FB	LD LD	LD LD	LD	GB GB	GB GB	GB GB	GB GB	GB GB	HB HB	HE HB	НВ	НВ	JE JE	JE JE	JE JE			KE KE	KE		
27,000 pF 27,000 pF	273	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	LD	LD		GB	GB	GB	GB	GB	НВ	НВ	НВ	НВ	JE	JE	JE			KE	KE		
33,000 pF	333	Ĵ	K	M	FB	FB	FB	FB	FB	FB	FB	FB	LD	LD		GB	GB	GB	GB	GB	НВ	НВ	НВ	НВ	JB	JB	JB			KE			
39,000 pF	393	J	K	М	FB	FB	FB	FB	FB	FB	FB	FB	LD	LD		GB	GB	GB	GB	GB	НВ	НВ	НВ	НВ	JB	JB	JB						
47,000 pF	473	J	K	М	FB	FB	FB	FB	FB	FB	FC	FC	LD	LD		GB	GB	GB	GB	GB	НВ	НВ	НВ	НВ	JB	JB	JB						
56,000 pF	563	J	K	M	FB	FB	FB	FB	FB	FB	FC	FC	LD	LD		GB	GB	GB	GB	GB	НВ	НВ	НВ	НВ	JB	JB	JB						
68,000 pF 82,000 pF	683 823	J	K	M	FB FB	FB FB	FB FB	FB FB	FB FB	FB FC	FC FF	FC FF	LD LD			GB GB	GB GB	GB GB	GB GB	GB GB	HB HB	HB HB	HB HB	HB HB	JB JC	JB JC	JB JC	JC	JC				
0.10 μF	104	J	K	M	FB	FB	FB	FB	FB	FD	FG	FG	LD			GB	GB	GB	GB	GB	НВ	НВ	НВ	НВ	JC	JC	JC	JC	JC	кс	KC	KC	KC
0.12 µF	124	J	K	M	FB	FB	FB	FB	FB	FD	' '	' '	LD			GB	GB	GB	GB	GB	НВ	НВ	НВ	HB	JC	JC	JC	JC	JC	KC	KC	KC	KC
0.15 µF	154	J	K	М	FC	FC	FC	FC	FC	FD			LD			GB	GB	GB	GE	GE	НВ	НВ	НВ	НВ	JC	JC	JC	JC	JC		KC	KC	KC
0.18 μF	184	J	K	М	FC	FC	FC	FC	FC	FD			LD			GB	GB	GB	GG	GG	НВ	НВ	НВ	НВ	JC	JC	JC	JC	JC		KC	KC	KC
0.22 µF	224	J	K	M	FC	FC	FC	FC	FC	FD						GB	GB	GB	GG	GG	НВ	НВ	НВ	НВ	JC	JC	JC	JC	JC		KC	KC	KC
0.27 µF	274	J	K	M	FC FD	FC FD	FC FD	FC FD	FC	FD						GB	GB	GG GG	GG GG	GG	HB HB	НВ	HB HB	HB HB	JC	JC	JC	JC	JC	KB KB	KC	KC	KC KC
0.33 μF 0.39 μF	334 394	J	K	M	FD	FD	FD	FD	FD FD	FD FD						GB GB	GB GB	GG	GG	GG	НВ	HB HB	HD	HD	JC	JC	JC JC	JC JC	JC	KB	KC KC	KC KC	KC
0.47 µF	474	J	K	M	FD	FD	FD	FD	FD	FD						GB	GB	GG	GJ	GJ	НВ	НВ	HD	HD	JC	JC	JC	JC	JC	KB	KC	KD	KD
0.56 µF	564	J	K	М	FD	FD	FD	FD	FD	FF			İ			GC	GC	GG			НВ	HD	HD	HD	JC	JC	JC	JD	JD	KB	KC	KD	KD
0.68 µF	684	J	K	M	FD	FD	FD	FD	FD	FG						GC	GC	GG			НВ	HD	HD	HD	JC	JC	JD	JD	JD	KB	KC	KD	KD
0.82 µF	824	J	K	M	FF	FF	FF	FF	FF	FL						GE	GE	GG			НВ	HF	HF	HF	JC	JC	JF	JF	JF	KB	KC	KE	KE
1.0 μF 1.2 μF	105 125	J	K	M	FH	FH	FH	FH	FH	FM						GE	GE	GG			HB HB	HF	HF	HF	JC	JC	JF	JF	JF	KB KB	KD KE	KE	KE KE
1.5 µF	155	J	K	M	FH	FH	FH	FH	FG												НС				JC	JC				KC	IXL	IXL	IXL
1.8 µF	185	Ĵ	K	M	FH	FH	FH	FH	FG												HD				JD	JD				KD			
2.2 µF	225	J	K	М	FJ	FJ	FJ	FJ	FG							GO	GO				HF				JF	JF				KD			
2.7 µF	275	J	K	М	FE	FE	FE	FG	FH																								
3.3 µF	335	J	K	M	FF	FF	FF	FM	FM																					1			
3.9 μF 4.7 μF	395 475	J	K	M	FG FC	FG FC	FG FC	FG FG	FK FS							GK	GK								JF	JF				1			
4.7 μ1 5.6 μF	565	J	K	M	FF	FF	FF	FH	. 5				l				J.								"	"				l			
6.8 µF	685	J	K	М	FG	FG	FG	FM																									
8.2 µF	825	J	K	М	FH	FH	FH	FK																									
10 μF	106	J	K	M	FH	FH	FH	FS¹								GK									JF	JO							
15 μF 22 μF	156 226	J	K	M	FM FS	FM FS																			10	JO							
ΖΖ μι	220	Vo	ltage		6.3	1 5	16	25	20	100	200	250	20	100	200	25	20	90	200	250	20	9	200	250	25	20	9	200	250	20	9	200	250
Cap	Cap	_	age C		9	8	4	3	5	1	2	7	5	1	2	3	5	1	2	A	5	1	2	A	3	5	1	2	A	5	1	2	8
	Code	_	erie						210				-	:180				181				C18	_				222		1			225	
									_				_										_							_		_	

 xx^1 Available only in K, M tolerance.



Table 2 – Chip Thickness/Packaging Quantities

Thickness	Case	Thickness ±	Paper C	Quantity	Plastic (Quantity	
Code	Size	Range (mm)	7" Reel	13" Reel	7" Reel	13" Reel	
ВВ	0402	0.50 ± 0.05	10,000	50,000	0	0	
СВ	0603	0.80 ± 0.07	4,000	10,000	0	0	
CF	0603	0.80 ± 0.07	4,000	15,000	0	0	
DE	0805	0.70 ± 0.20	4,000	10,000	0	0	
DC	0805	0.78 ± 0.10	4,000	10,000	0	0	
DD	0805	0.90 ± 0.10	4,000	10,000	0	0	
DG	0805	1.25 ± 0.15	0	0	2,500	10,000	
DH	0805	1.25 ± 0.20	0	0	2,500	10,000	
EB	1206	0.78 ± 0.10	4,000	10,000	4,000	10,000	
EC	1206	0.90 ± 0.10	0	0	4,000	10,000	
ED	1206	1.00 ± 0.10	0	0	2,500	10,000	
EE	1206	1.10 ± 0.10	0	0	2,500	10,000	
EF	1206	1.20 ± 0.15	0	0	2,500	10,000	
EM	1206	1.25 ± 0.15	0	0	2,500	10,000	
EG	1206	1.60 ± 0.15	0	0	2,000	8,000	
EH	1206	1.60 ± 0.20	0	0	2,000	8,000	
FB	1210	0.78 ± 0.10	0	0	4,000	10,000	
FC	1210	0.90 ± 0.10	0	0	4,000	10,000	
FD	1210	0.95 ± 0.10	0	0	4,000	10,000	
FE	1210	1.00 ± 0.10	0	0	2,500	10,000	
FF	1210	1.10 ± 0.10	0	0	2,500	10,000	
FG	1210	1.25 ± 0.15	0	0	2,500	10,000	
FL	1210	1.40 ± 0.15	0	0	2,000	8,000	
FH	1210	1.55 ± 0.15	0	0	2,000	8,000	
FM	1210	1.70 ± 0.20	0	0	2,000	8,000	
FJ	1210	1.85 ± 0.20	0	0	2,000	8,000	
FK	1210	2.10 ± 0.20	0	0	2,000	8,000	
FS	1210	2.50 ± 0.30	0	0	1,000	4,000	
LD	1808	0.90 ± 0.10	0	0	2,500	10,000	
LF	1808	1.00 ± 0.15	0	0	2,500	10,000	
GB	1812	1.00 ± 0.10	0	0	1,000	4,000	
GC	1812	1.10 ± 0.10	0	0	1,000	4,000	
GD	1812	1.25 ± 0.15	0	0	1,000	4,000	
GE	1812	1.30 ± 0.10	0	0	1,000	4,000	
GH	1812	1.40 ± 0.15	0	0	1,000	4,000	
GG	1812	1.55 ± 0.10	0	0	1,000	4,000	
GK	1812	1.60 ± 0.20	0	0	1,000	4,000	
GJ	1812	1.70 ± 0.15	0	0	1,000	4,000	
GO	1812	2.50 ± 0.20	0	0	500	2,000	
НВ	1825	1.10 ± 0.15	0	0	1,000	4,000	
HC	1825	1.15 ± 0.15	0	0	1,000	4,000	
HD	1825	1.30 ± 0.15	0	0	1,000	4,000	
HE	1825	1.40 ± 0.15	0	0	1,000	4,000	
HF	1825	1.50 ± 0.15	0	0	1,000	4,000	
JB	2220	1.00 ± 0.15	0	0	1,000	4,000	
JC	2220	1.10 ± 0.15	0	0	1,000	4,000	
JD	2220	1.30 ± 0.15	0	0	1,000	4,000	
JE	2220	1.40 ± 0.15	0	0	1,000	4,000	
JF	2220	1.50 ± 0.15	0	0	1,000	4,000	
JO	2220	2.40 ± 0.15	0	0	500	2,000	
KB	2225	1.00 ± 0.15	0	0	1,000	4,000	
KC	2225	1.10 ± 0.15	0	0	1,000	4,000	
KD	2225	1.30 ± 0.15	0	0	1,000	4,000	
KE	2225	1.40 ± 0.15	0	0	1,000	4,000	
Thickness	Case	Thickness ±	7" Reel	13" Reel	7" Reel	13" Reel	
Code	Size	Range (mm)	Paper C	Quantity	Plastic (Quantity	

Package quantity based on finished chip thickness specifications.



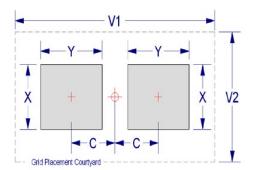
Table 3 - Chip Capacitor Land Pattern Design Recommendations per IPC-7351

EIA Size Code	Metric Size Code	ı		sity Lev mum (M rotrusio	lost))		Media	sity Lev an (Nor rotrusio			Density Level C: Minimum (Least) Land Protrusion (mm)						
0000	0000	С	Y	X	V1	V2	С	Y	X	V1	V2	С	Y	X	V1	V2		
0402	1005	0.50	0.72	0.72	2.20	1.20	0.45	0.62	0.62	1.90	1.00	0.40	0.52	0.52	1.60	0.80		
0603	1608	0.90	1.15	1.10	4.00	2.10	0.80	0.95	1.00	3.10	1.50	0.60	0.75	0.90	2.40	1.20		
0805	2012	1.00	1.35	1.55	4.40	2.60	0.90	1.15	1.45	3.50	2.00	0.75	0.95	1.35	2.80	1.70		
1206	3216	1.60	1.35	1.90	5.60	2.90	1.50	1.15	1.80	4.70	2.30	1.40	0.95	1.70	4.00	2.00		
1210	3225	1.60	1.35	2.80	5.65	3.80	1.50	1.15	2.70	4.70	3.20	1.40	0.95	2.60	4.00	2.90		
1210¹	3225	1.50	1.60	2.90	5.60	3.90	1.40	1.40	2.80	4.70	3.30	1.30	1.20	2.70	4.00	3.00		
1808	4520	2.30	1.75	2.30	7.40	3.30	2.20	1.55	2.20	6.50	2.70	2.10	1.35	2.10	5.80	2.40		
1812	4532	2.15	1.60	3.60	6.90	4.60	2.05	1.40	3.50	6.00	4.00	1.95	1.20	3.40	5.30	3.70		
1825	4564	2.15	1.60	6.90	6.90	7.90	2.05	1.40	6.80	6.00	7.30	1.95	1.20	6.70	5.30	7.00		
2220	5650	2.75	1.70	5.50	8.20	6.50	2.65	1.50	5.40	7.30	5.90	2.55	1.30	5.30	6.60	5.60		
2225	5664	2.70	1.70	6.90	8.10	7.90	2.60	1.50	6.80	7.20	7.30	2.50	1.30	6.70	6.50	7.00		

¹ Only for capacitance values ≥ 22 μF

Density Level A: For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes. KEMET only recommends wave soldering of EIA 0603, 0805 and 1206 case sizes.

Density Level B: For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes. **Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC–7351).



Soldering Process

Recommended Soldering Technique:

- Solder wave or solder reflow for EIA case sizes 0603, 0805 and 1206
- All other EIA case sizes are limited to solder reflow only

Recommended Soldering Profile:

KEMET recommends following the guidelines outlined in IPC/JEDEC J-STD-020



Table 4 – Performance & Reliability: Test Methods and Conditions

Stress	Reference	Test or Inspection Method
Terminal Strength	JIS-C-6429	Appendix 1, Note: Force of 1.8 kg for 60 seconds.
Board Flex	JIS-C-6429	Appendix 2, Note: Standard termination system – 2.0 mm (minimum) for all except 3 mm for C0G. Flexible termination system – 3.0 mm (minimum).
		Magnification 50 X. Conditions:
Solderability	J-STD-002	a) Method B, 4 hours @ 155°C, dry heat @ 235°C
Solderability	J-31D-002	b) Method B @ 215°C category 3
		c) Method D, category 3 @ 260°C
Temperature Cycling	JESD22 Method JA-104	1,000 Cycles (-55°C to +125°C). Measurement at 24 hours +/- 2 hours after test conclusion.
Biased Humidity	MIL-STD-202 Method 103	Load Humidity: 1,000 hours 85°C/85% RH and rated voltage. Add 100 K ohm resistor. Measurement at 24 hours +/- 2 hours after test conclusion. Low Volt Humidity: 1,000 hours 85°C/85% RH and 1.5 V. Add 100 K ohm resistor. Measurement at 24 hours +/- 2 hours after test conclusion.
Moisture Resistance	MIL-STD-202 Method 106	t = 24 hours/cycle. Steps 7a and 7b not required. Unpowered. Measurement at 24 hours +/- 2 hours after test conclusion.
Thermal Shock	MIL-STD-202 Method 107	-55°C/+125°C. Note: Number of cycles required – 300, maximum transfer time – 20 seconds, dwell time – 15 minutes. Air – Air.
High Temperature Life	MIL-STD-202 Method 108 /EIA-198	1,000 hours at 125°C (85°C for X5R, Z5U and Y5V) with 2 X rated voltage applied.
Storage Life	MIL-STD-202 Method 108	150°C, 0 VDC for 1,000 hours.
Vibration	MIL-STD-202 Method 204	5 g's for 20 min., 12 cycles each of 3 orientations. Note: Use 8" X 5" PCB 0.031" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10 – 2,000 Hz
Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213, Condition F.
Resistance to Solvents	MIL-STD-202 Method 215	Add aqueous wash chemical, OKEM Clean or equivalent.

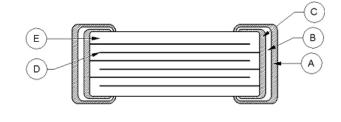
Storage and Handling

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature—reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within 1.5 years of receipt.



Construction

Reference	lt	em	Material
А		Finish	SnPb (5% minimum)
В	Termination System	Barrier Layer	Ni
С	, ,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	Base Metal	Cu
D	Inner E	Electrode	Ni
Е	Dielectri	ic Material	BaTiO ₃



Note: Image is exaggerated in order to clearly identify all components of construction.



Capacitor Marking (Optional):

These surface mount multilayer ceramic capacitors are normally supplied unmarked. If required, they can be marked as an extra cost option. Marking is available on most KEMET devices but must be requested using the correct ordering code identifier(s). If this option is requested, two sides of the ceramic body will be laser marked with a "K" to identify KEMET, followed by two characters (per EIA–198 - see table below) to identify the capacitance value. EIA 0603 case size devices are limited to the "K" character only.

Marking appears in legible contrast. Illustrated below is an example of an MLCC with laser marking of "KA8", which designates a KEMET device with rated capacitance of 100 μ F. Orientation of marking is vendor optional.



Laser marking option is not available on:

- C0G, Ultra Stable X8R and Y5V dielectric devices
- EIA 0402 case size devices
- EIA 0603 case size devices with Flexible Termination option.
- · KPS Commercial and Automotive Grade stacked devices.

		Capacit	tance (p	F) For				I Identifi	ers	
Alpha						Numera	ıl			
	9	0	1	2	3	4	5	6	7	8
Character					Capa	acitance	e (pF)			
Α	0.1	10	10	100	1,000	10,000	100,000	1,000,000	10,000,000	100,000,000
В	0.11	1.1	11	110	1,100	11,000	110,000	1,100,000	11,000,000	110,000,000
С	0.12	12	12	120	1,200	12,000	120,000	1,200,000	12,000,000	120,000,000
D	0.13	13	13	130	1,300	13,000	130,000	1,300,000	13,000,000	130,000,000
E	0.15	15	15	150	1,500	15,000	150,000	1,500,000	15,000,000	150,000,000
F	0.16	16	16	160	1,600	16,000	160,000	1,600,000	16,000,000	160,000,000
G	0.18	18	18	180	1,800	18,000	180,000	1,800,000	18,000,000	180,000,000
Н	0.2	20	20	200	2,000	20,000	200,000	2,000,000	20,000,000	200,000,000
J	0.22	22	22	220	2,200	22,000	220,000	2,200,000	22,000,000	220,000,000
K	0.24	2.4	24	240	2,400	24,000	240,000	2,400,000	24,000,000	240,000,000
L	0.27	2.7	27	270	2,700	27,000	270,000	2,700,000	27,000,000	270,000,000
М	0.3	3 0	30	300	3,000	30,000	300,000	3,000,000	30,000,000	300,000,000
N	0.33	3 3	33	330	3,300	33,000	330,000	3,300,000	33,000,000	330,000,000
Р	0.36	3 6	36	360	3,600	36,000	360,000	3,600,000	36,000,000	360,000,000
Q	0.39	3 9	39	390	3,900	39,000	390,000	3,900,000	39,000,000	390,000,000
R	0.43	4 3	43	430	4,300	43,000	430,000	4,300,000	43,000,000	430,000,000
S	0.47	4.7	47	470	4,700	47,000	470,000	4,700,000	47,000,000	470,000,000
T	0.51	5.1	51	510	5,100	51,000	510,000	5,100,000	51,000,000	510,000,000
U	0.56	56	56	560	5,600	56,000	560,000	5,600,000	56,000,000	560,000,000
V	0.62	62	62	620	6,200	62,000	620,000	6,200,000	62,000,000	620,000,000
W	0.68	68	68	680	6,800	68,000	680,000	6,800,000	68,000,000	680,000,000
Х	0.75	75	75	750	7,500	75,000	750,000	7,500,000	75,000,000	750,000,000
Υ	0.82	8 2	82	820	8,200	82,000	820,000	8,200,000	82,000,000	820,000,000
Z	0.91	9.1	91	910	9,100	91,000	910,000	9,100,000	91,000,000	910,000,000
а	0.25	25	25	250	2,500	25,000	250,000	2,500,000	25,000,000	250,000,000
b	0.35	3 5	35	350	3,500	35,000	350,000	3,500,000	35,000,000	350,000,000
d	0.4	4 0	40	400	4,000	40,000	400,000	4,000,000	40,000,000	400,000,000
е	0.45	4 5	45	450	4,500	45,000	450,000	4,500,000	45,000,000	450,000,000
f	0.5	5 0	50	500	5,000	50,000	500,000	5,000,000	50,000,000	500,000,000
m	0.6	6 0	60	600	6,000	60,000	600,000	6,000,000	60,000,000	600,000,00
n	0.7	70	70	700	7,000	70,000	700,000	7,000,000	70,000,000	700,000,00
t	0.8	8 0	80	800	8,000	80,000	800,000	8,000,000	80,000,000	800,000,000
у	0.9	9 0	90	900	9,000	90,000	900,000	9,000,000	90,000,000	900,000,000



Tape & Reel Packaging Information

KEMET offers multilayer ceramic chip capacitors packaged in 8, 12 and 16 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems. See Table 2 for details on reeling quantities for commercial chips.

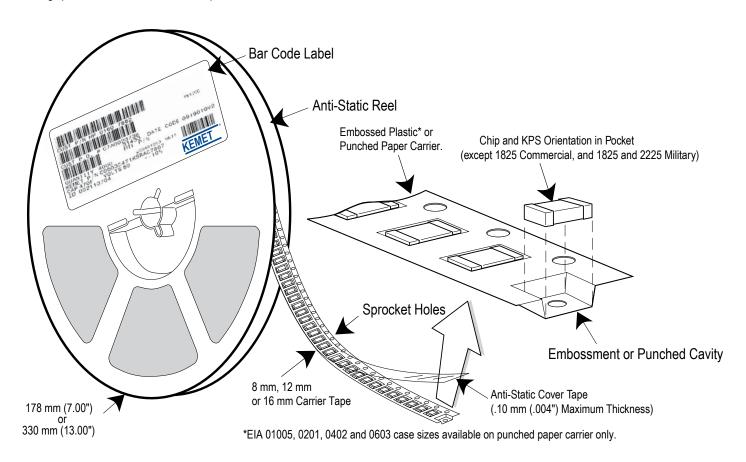


Table 5 – Carrier Tape Configuration – Embossed Plastic & Punched Paper (mm)

EIA Case Size	Tape Size (W)*	Pitch (P₁)*
01005 – 0402	8	2
0603 – 1210	8	4
1805 – 1808	12	4
≥ 1812	12	8
KPS 1210	12	8
KPS 1812 & 2220	16	12
Array 0508 & 0612	8	4

^{*}Refer to Figures 1 & 2 for W and P, carrier tape reference locations.

^{*}Refer to Tables 6 & 7 for tolerance specifications.



Figure 1 – Embossed (Plastic) Carrier Tape Dimensions

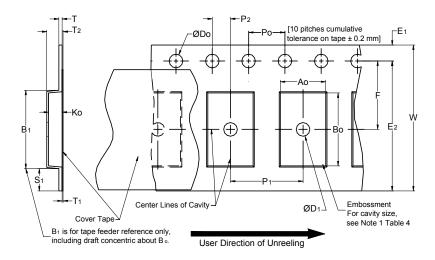


Table 6 – Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)									
Tape Size	D ₀	D ₁ Minimum Note 1	E ₁	P ₀	P ₂	R Reference Note 2	S ₁ Minimum Note 3	T Maximum	T ₁ Maximum
8 mm		1.0 (0.039)				25.0 (0.984)			
12 mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)	1.5	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	30	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)
16 mm	(0.059)					(1.181)			
			Variable Dime	ensions — Mil	limeters (Inch	es)			
Tape Size Pitch B ₁ Maximum E ₂ Note 4 Minimum		F	P ₁	T ₂ Maximum	W Maximum	A_0,B_0	& K ₀		
8 mm	Single (4 mm)	4.35 (0.171)	6.25 (0.246)	3.5 ±0.05 (0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	2.5 (0.098)	8.3 (0.327)		
12 mm	Single (4 mm) & Double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5 ±0.05 (0.217 ±0.002)	8.0 ±0.10 (0.315 ±0.004)	4.6 (0.181)	12.3 (0.484)	Not	e 5
16 mm	Triple (12 mm)	12.1 (0.476)	14.25 (0.561)	7.5 ±0.05 (0.138 ±0.002)	12.0 ±0.10 (0.157 ±0.004)	4.6 (0.181)	16.3 (0.642)		

- The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.
- 2. The tape with or without components shall pass around R without damage (see Figure 6).
- 3. If S, < 1.0 mm, there may not be enough area for cover tape to be properly applied (see EIA Standard 481 paragraph 4.3 section b).
- 4. B, dimension is a reference dimension for tape feeder clearance only.
- 5. The cavity defined by A_0 , B_0 and K_0 shall surround the component with sufficient clearance that:
 - (a) the component does not protrude above the top surface of the carrier tape.
 - (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - (c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm tapes (see Figure 3).
 - (d) lateral movement of the component is restricted to 0.5 mm maximum for 8 and 12 mm wide tape and to 1.0 mm maximum for 16 mm tape (see Figure 4).
 - (e) for KPS Series product, A_a and B_a are measured on a plane 0.3 mm above the bottom of the pocket.
 - (f) see Addendum in EIA Standard 481 for standards relating to more precise taping requirements.



Figure 2 – Punched (Paper) Carrier Tape Dimensions

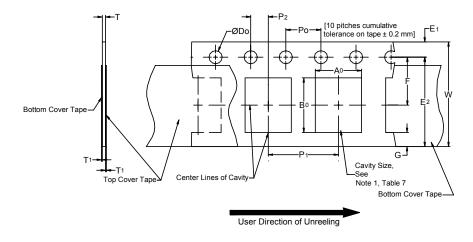


Table 7 – Punched (Paper) Carrier Tape Dimensions

Metric will govern

	Constant Dimensions — Millimeters (Inches)								
Tape Size	D ₀	E ₁	P ₀	P ₂	T ₁ Maximum	G Minimum	R Reference Note 2		
8 mm	1.5 +0.10 -0.0 (0.059 +0.004 -0.0)	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	0.10 (0.004) Maximum	0.75 (0.030)	25 (0.984)		
	Variable Dimensions — Millimeters (Inches)								
Tape Size	Pitch	E2 Minimum	F	P ₁	T Maximum	W Maximum	A_0B_0		
8 mm	Half (2 mm)	6.25	3.5 ±0.05	2.0 ±0.05 (0.079 ±0.002)	1.1	8.3 (0.327)	Note 1		
8 mm	Single (4 mm)	(0.246)	(0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	(0.098)	8.3 (0.327)	Note 1		

- 1. The cavity defined by A_{o} , B_{o} and T shall surround the component with sufficient clearance that:
 - a) the component does not protrude beyond either surface of the carrier tape.
 - b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - c) rotation of the component is limited to 20° maximum (see Figure 3).
 - d) lateral movement of the component is restricted to 0.5 mm maximum (see Figure 4).
 - e) see Addendum in EIA Standard 481 for standards relating to more precise taping requirements.
- 2. The tape with or without components shall pass around R without damage (see Figure 6).



Packaging Information Performance Notes

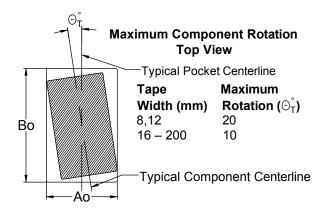
- 1. Cover Tape Break Force: 1.0 Kg minimum.
- 2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength
8 mm	0.1 to 1.0 Newton (10 to 100 gf)
12 and 16 mm	0.1 to 1.3 Newton (10 to 130 gf)

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 ± 10 mm/minute.

3. Labeling: Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. *Refer to EIA Standards 556 and 624.*

Figure 3 – Maximum Component Rotation



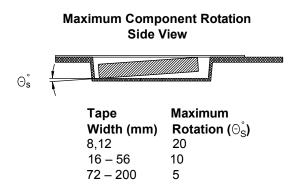


Figure 4 - Maximum Lateral Movement

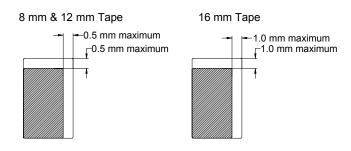


Figure 5 - Bending Radius

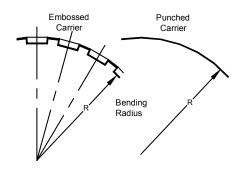
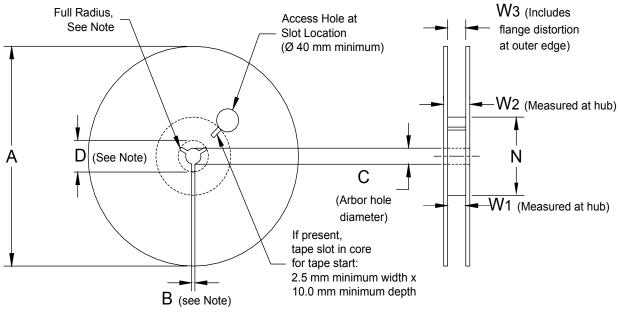




Figure 6 – Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

Table 8 - Reel Dimensions

Metric will govern

	Constant Dimensions — Millimeters (Inches)						
Tape Size	A	B Minimum	С	D Minimum			
8 mm	178 ±0.20						
12 mm	(7.008 ±0.008) or	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)			
16 mm	330 ±0.20 (13.000 ±0.008)	(0.000)					
	Variable	Dimensions — Millimeter	s (Inches)				
Tape Size	N Minimum	W ₁	W ₂ Maximum	W ₃			
8 mm		8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)				
12 mm	50 (1.969)	12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	Shall accommodate tape width without interference			
16 mm		16.4 +2.0/-0.0 (0.646 +0.078/-0.0)	22.4 (0.882)				



Figure 7 – Tape Leader & Trailer Dimensions

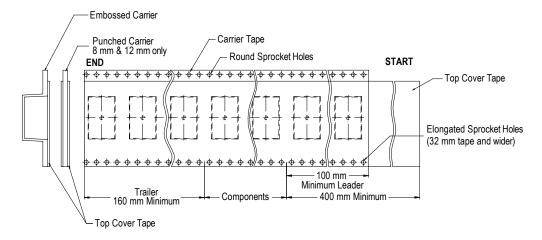
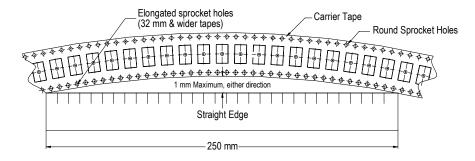
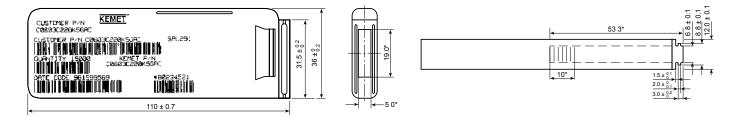


Figure 8 – Maximum Camber



Bulk Cassette Packaging (Ceramic Chips Only)

Meets Dimensional Requirements IEC–286 and EIAJ 7201 *Unit mm *Reference*



Capacitor Dimensions for Bulk Cassette

Cassette Packaging - Millimeters

EIA Size Code	Metric Size Code	L Length	W Width	B Bandwidth	S Separation Minimum	T Thickness	Number of Pieces/Cassette
0402	1005	1.0 ±0.05	0.5 ±0.05	0.2 to 0.4	0.3	0.5 ±0.05	50,000
0603	1608	1.6 ±0.07	0.8 ±0.07	0.2 to 0.5	0.7	0.8 ±0.07	15,000



KEMET Corporation World Headquarters

2835 KEMET Way Simpsonville, SC 29681

Mailing Address: P.O. Box 5928 Greenville, SC 29606

www.kemet.com Tel: 864-963-6300 Fax: 864-963-6521

Corporate Offices

Fort Lauderdale, FL Tel: 954-766-2800

North America

Southeast

Lake Mary, FL Tel: 407-855-8886

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Asia

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